TE0803 StarterKit

Revision v.38

Exported on 2024-08-26

Online version of this document:

https://wiki.trenz-electronic.de/display/PD/TE0803+StarterKit

1 Table of Contents

2 Table of Figures

3 Table of Tables

4 Overview

Linux with basic periphery of TE0808 StarterKit (TEBF0808 Carrier).
Refer to http://trenz.org/te0803-info for the current online version of this manual and other available documentation.

4.1 Key Features

- Vitis/Vivado 2022.2
- TEBF0808
- PetaLinux
- USB
- ETH
- MAC from EEPROM
- PCIe
- SATA
- SD
- I2C
- RGPIO
- Display Port (DP)
- user LED access
- Modified FSBL for Si5338 programming

4.2 Revision History

Expand List

Date	Vivado	Project Built	Authors	Description
2023-09-14	2022.2	TE0803-StarterKit-vivado_2022.2-build_8_20230914124643.zip TE0803-StarterKit_noprebuilt-vivado_2022.2-build_8_20230914124643.zip	Manuela Strücker	• 2022.2 update • new assembly variants
2022-10-17	2021.2.1	TE0803-StarterKit-vivado_2021.2-build_18_20221017093105.zip TE0803-StarterKit_noprebuilt-vivado_2021.2-	Manuela Strücker	• script update

Date	Vivado	Project Built	Authors	Description
		build_18_20221017093105.zip		
2022-08-30	2021.2.1	TE0803-StarterKit-vivado_2021.2-build_15_20220830131524.zip TE0803-StarterKit_noprebuilt-vivado_2021.2-build_15_20220830131524.zip	Manuela Strücker	• new assembly variants
2022-04-05	2021.2	TE0803-StarterKit-vivado_2021.2-build_11_20220405095407.zip TE0803-StarterKit_noprebuilt-vivado_2021.2-build_11_20220405095407.zip	Manuela Strücker	• 2021.2 update
2021-09-06	2020.2	TE0803-StarterKit_noprebuilt-vivado_2020.2-build_7_20210906104631.zip TE0803-StarterKit-vivado_2020.2-build_7_20210906104617.zip	Manuela Strücker	• 2020.2 update
2020-04-06	2019.2	TE0803-StarterKit_noprebuilt-vivado_2019.2-build_9_20200406082458.zip TE0803-StarterKit-vivado_2019.2-build_9_20200406082321.zip	John Hartfiel	• new assembly variants

Date	Vivado	Project Built	Authors	Description
2020-03-25	2019.2	TE0803-StarterKit_noprebuilt-vivado_2019.2-build_8_20200325082516.zip TE0803-StarterKit-vivado_2019.2-build_8_20200325082450.zip	John Hartfiel	• script update
2020-01-23	2019.2	TE0803-StarterKit_noprebuilt-vivado_2019.2-build_3_20200123065955.zip TE0803-StarterKit-vivado_2019.2-build_3_20200123065933.zip	John Hartfiel	• 2019.2 update • Vitis support • FSBL SI programming procedure update • petalinux device tree and u-boot update
2019-05-07	2018.3	TE0803-StarterKit-vivado_2018.3-build_05_20190507093424.zip TE0803-StarterKit_noprebuilt-vivado_2018.3-build_05_20190507093443.zip	John Hartfiel	• new assembly variant • TE Script update • rework of the FSBLs • SI5338 CLKBuilder Pro Project • some additional Linux features • MAC from EEPROM • new assembly variants • remove special compiler flags, which was needed in 2018.2
2018-10-25	2018.2	TE0803-Starterkit-vivado_2018.2-build_03_20181026141553.zip TE0803-Starterkit_noprebuilt-vivado_2018.2-	John Hartfiel	• new assembly variant

Date	Vivado	Project Built	Authors	Description
		build_03_20181026141611.zip		
2018-08-14	2018.2	TE0803-Starterkit-vivado_2018.2-build_02_20180814103204.zip TE0803-Starterkit_noprebuilt-vivado_2018.2-build_02_20180814103221.zip	John Hartfiel	• new assembly variant
2018-07-23	2018.2	TE0803-Starterkit-vivado_2018.2-build_02_20180723204618.zip TE0803-Starterkit_noprebuilt-vivado_2018.2-build_02_20180723204638.zip	John Hartfiel	• correction on FSBL
2018-07-12	2018.2	TE0803-Starterkit_noprebuilt-vivado_2018.2-build_02_20180713085800.zip TE0803-Starterkit-vivado_2018.2-build_02_20180713085740.zip	John Hartfiel	• small petalinux changes • IO renaming • PL Design changes • additional notes for FSBL generated with Win SDK • changed *.bif
2018-05-17	2017.4	TE0803-Starterkit_noprebuilt-vivado_2017.4-build_09_20180517141540.zip TE0803-Starterkit-vivado_2017.4-build_09_20180517141523.zip	John Hartfiel	• new assembly variant • solved Linux flash issue

Date	Vivado	Project Built	Authors	Description
2018-04-11	2017.4	TE0803-Starterkit_noprebuilt-vivado_2017.4-build_07_20180411082139.zip TE0803-Starterkit-vivado_2017.4-build_07_20180411082116.zip	John Hartfiel	• bugfix TE0803-01-04EG board part file
2018-02-13	2017.4	TE0803-Starterkit_noprebuilt-vivado_2017.4-build_06_20180213120642.zip TE0803-Starterkit-vivado_2017.4-build_06_20180213120615.zip	John Hartfiel	• new assembly variant
2018-02-06	2017.4	TE0803-Starterkit_noprebuilt-vivado_2017.4-build_05_20180206082527.zip TE0803-Starterkit-vivado_2017.4-build_05_20180206082513.zip	John Hartfiel	• same CLK for both VIO
2018-02-05	2017.4	TE0803-Starterkit_noprebuilt-vivado_2017.4-build_05_20180205154248.zip TE0803-Starterkit-vivado_2017.4-build_05_20180205154230.zip	John Hartfiel	• new assembly variant • solved JTAG/ Linux issue
2018-01-31	2017.4	TE0803-Starterkit-vivado_2017.4-build_05_20180131124	John Hartfiel	• new assembly variant

Date	Vivado	Project Built	Authors	Description
		042.zip TE0803-Starterkit_noprebuilt-vivado_2017.4-build_05_20180131124057.zip		
2018-01-18	2017.4	TE0803-Starterkit-vivado_2017.4-build_05_20180118164553.zip TE0803-Starterkit_noprebuilt-vivado_2017.4-build_05_20180118164613.zip	John Hartfiel	• initial release

Table 1: Design Revision History

4.3 Release Notes and Know Issues

Issues	Description	Workaround/Solution	To be fixed version
Xilinx Software	Incompatibility of board files for ZynqMP with eMMC activated between 2021.2 and 2021.2.1 patch, see Xilinx Forum Request[1]	use corresponding board files for the Vivado versions	--
MAC from EEPROM	The MAC address stored in the EEPROM is not read out and initialised correctly during start-up. This is caused by two I2C expanders each	Switching the second I2C expander (i2cswitch@77) to another channel in the fsbl solves the error during the start-up procedure.	**Solved** with 20220405 update

1 https://support.xilinx.com/s/feed/0D54U00005Wbon6SAB?language=en_US

Issues	Description	Workaround/Solution	To be fixed version
	switched to the same EEPROM with the same address i2cswitch@73 --> i2c@5 --> reg = <0x50> and i2cswitch@77 --> i2c@4 --> reg = <0x50>		
QSPI Flash	Flash programming is not supported with boot mode QSPI or SD.	If flash programming fails, configure device for JTAG boot mode and try again or use oder Vivado Versions for programming. (Vivado 2020.2 or 2019.2)	--
Flash access on Linux	Device tree is not correct on Linux	add compatibility to "compatible “jedec,spi-nor”"	**Solved** with 20180517 update
USB UART Terminal is blocked / SDK Debugging is blocked	This happens only with 2017.4 Linux , when JTAG connection is established on Vivado HW Manager.	Do not use HW Manager connection, or if debugging is nessecary: 1. Boot linux with usb terminal 2. From the terminal: root root mount ifconfig eth0 3. Open two new SSH terminals via ethernet: root root , run user application ... 4. Exit and close the usb terminal	**Solved** with 20180205 update

Table 2: Known Issues

4.4 Requirements

4.4.1 Software

Software	Version	Note
Vitis	2022.2	needed, Vivado is included into Vitis installation
PetaLinux	2022.2	needed
SI ClockBuilder Pro	---	optional

Table 3: Software

4.4.2 Hardware

TE Board Part Files.[2]
Complete List is available on "<project folder>\board_files*_board_files.csv"

Design supports following modules:

Expand List

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-01-02CG-1E	2cg_2gb	REV01	2GB	64MB	NA	NA	NA
TE0803-01-02CG-1EA	2cg_2gb	REV01	2GB	128MB	NA	NA	NA

2 https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-01-02EG-1E	2eg_2gb	REV01	2GB	64MB	NA	NA	NA
TE0803-01-02EG-1EA	2eg_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-01-03CG-1E	3cg_2gb	REV01	2GB	64MB	NA	NA	NA
TE0803-01-03CG-1EA	3cg_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-01-03EG-1E	3eg_2gb	REV01	2GB	64MB	NA	NA	NA
TE0803-01-03EG-1EA	3eg_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-01-04CG-1EA	4cg_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-01-04CG-1EB	4cg_2gb	REV01	2GB	256MB	NA	NA	NA
TE0803-01-04EG-1EA	4eg_2gb	REV01	2GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-01-04EV-1E3	4ev_2gb	REV01	2GB	128MB	NA	1 mm connectors	NA
TE0803-01-05EV-1EA	5ev_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-01-05EV-1IA	5ev_i_2gb	REV01	2GB	128MB	NA	NA	NA
TE0803-02-03EG-1EB	3eg_4gb	REV02| REV01	4GB	128MB	NA	NA	NA
TE0803-02-04EG-1E3	4eg_4gb	REV02	4GB	128MB	NA	1 mm connectors	NA
TE0803-02-04EV-1E3	4ev_4gb	REV02	4GB	128MB	NA	1 mm connectors	NA
TE0803-02-04EV-1EA	4ev_2gb	REV02| REV01	2GB	128MB	NA	NA	NA
TE0803-03-2AE11-A	2cg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-2BE11-A	2eg_2gb	REV03	2GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-03-3AE11-A	3cg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-3AE11-AK	3cg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-3BE11-A	3eg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-3BE21-A	3eg_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-3BE31-A*	3eg_8gb	REV03	8GB	128MB	NA	NA	dual die ddr
TE0803-03-3BI21-A	3eg_i_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-3RI21-A	3eg_li_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-4AE11-A	4cg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-4BE11-A	4eg_2gb	REV03	2GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-03-4BE21-L	4eg_4gb	REV03	4GB	128MB	NA	1 mm connectors	NA
TE0803-03-4BI21-A	4eg_i_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-4BI21-X	4eg_i_4gb	REV03	4GB	128MB	NA	NA	U41 replaced with diode
TE0803-03-4BI61-A	4eg_8gb	REV03	8GB	128MB	NA	NA	dual die ddr
TE0803-03-4BI61-X	4eg_8gb	REV03	8GB	128MB	NA	NA	dual die ddr
TE0803-03-4DE11-A	4ev_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-4DE21-L	4ev_4gb	REV03	4GB	128MB	NA	1 mm connectors	NA
TE0803-03-4DE21-LZ	4ev_4gb	REV03	4GB	128MB	NA	1 mm connectors	NA
TE0803-03-4DI21-D	4ev_i_4gb	REV03	4GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-03-4DI21-L	4ev_i_4gb	REV03	4GB	128MB	NA	1 mm connectors	NA
TE0803-03-4GE11-A	4eg_2_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-4GE21-L	4eg_2_4gb	REV03	4GB	128MB	NA	1 mm connectors	NA
TE0803-03-4GI11-A	4eg_2i_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-4GI21-A	4eg_2i_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-5BE11-A	5eg_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-5DE11-A	5ev_2gb	REV03	2GB	128MB	NA	NA	NA
TE0803-03-5DI21-A	5ev_i_4gb	REV03	4GB	128MB	NA	NA	NA
TE0803-03-5DI24-A	5ev_i_4gb	REV03	4GB	512MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-03-S003	4ev_2gb	REV04	2GB	128MB	NA	NA	CAO
TE0803-03-S005	4eg_2gb	REV03	2GB	128MB	NA	NA	CAO: TE0803-03-4BI1?-A
TE0803-03-S006	4ev_4gb	REV04	4GB	128MB	NA	1 mm connectors	CAO
TE0803-04-2AE11-A	2cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-2BE11-A	2eg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-2BE11-AK	2eg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-3AE11-A	3cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-3AE11-AK	3cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-3BE11-A	3eg_2gb	REV04	2GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-04-3BE21-L	3eg_4gb	REV04	4GB	128MB	NA	NA	NA
TE0803-04-4AE11-A	4cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4AE11-AK	4cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4AE11-AZ	4cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4BE11-A	4eg_2gb	REV04	2GB	128MB	NA	NA	CAO
TE0803-04-4BE11-AK	4eg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4BE21-L	4eg_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA
TE0803-04-4BI21-A	4eg_i_4gb	REV04	4GB	128MB	NA	NA	NA
TE0803-04-4BI21-X	4eg_i_4gb	REV04	4GB	128MB	NA	NA	U41 replaced with diode

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-04-4BI61-A	4eg_8gb	REV04	8GB	128MB	NA	NA	dual die ddr
TE0803-04-4BI61-X	4eg_8gb	REV04	8GB	128MB	NA	NA	dual die ddr
TE0803-04-4DE11-A	4ev_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4DE11-AZ	4ev_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-4DE21-L	4ev_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA
TE0803-04-4DE21-LZ	4ev_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA
TE0803-04-4DI21-D	4ev_i_4gb	REV04	4GB	128MB	NA	NA	NA
TE0803-04-4DI21-L	4ev_i_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA
TE0803-04-4GE21-L	4eg_2_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-04-4GI21-A	4eg_2i_4gb	REV04	4GB	128MB	NA	NA	NA
TE0803-04-5BE11-A	5eg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-5DE11-A	5ev_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-5DI21-A	5ev_i_4gb	REV04	4GB	128MB	NA	NA	NA
TE0803-04-S009	4eg_2_4gb	REV04	4GB	128MB	NA	1 mm connectors	CAO: TE0803-04-4GE21-L
TE0803-04-S010	5ev_2gb	REV04	2GB	128MB	NA	NA	CAO: TE0803-04-5DE11-A
TE0803-04-S011	4eg_2_4gb	REV04	4GB	64MB	NA	1 mm connectors	CAO: TE0803-04-4GE25-L
TE0803-04-S012	2cg_2gb	REV04	2GB	128MB	NA	NA	CAO
TE0803-04-S013	3cg_2gb	REV04	2GB	128MB	NA	NA	NA

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EMMC	Others	Notes
TE0803-04-S014	4eg_2_4gb	REV04	4GB	64MB	NA	1 mm connectors	CAO: TE0803-04-4GE2?-LZ
TE0803-04-S016	4cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-S017	2eg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-S018	4eg_2_4gb	REV04	4GB	128MB	NA	1 mm connectors	NA
TE0803-04-S020	4cg_2gb	REV04	2GB	128MB	NA	NA	NA
TE0803-04-S022	4eg_2_4gb	REV04	4GB	128MB	NA	1 mm connectors	CAO: TE0803-04-4GE21-LZ
TE0803-04-S023	4eg_2_4gb	REV04	4GB	128MB	NA	1 mm connectors	CAO: TE0803-04-4GE81-L
TE0803-04-S026	5ev_i_4gb	REV04	4GB	128MB	NA	NA	CAO: TE0803-04-5DI21-A

Table 4: Hardware Modules

*used as reference

Note: Design contains also Board Part Files for TE0803 only configuration, this board part files are not used for this reference design.

Design supports following carriers:

Carrier Model	Notes
TEBF0808*	Used as reference carrier. **Important**: CPLD Firmware REV07 or newer is recommended

Table 5: Hardware Carrier
*used as reference

Additional HW Requirements:

Additional Hardware	Notes
DP Monitor	Optional HW Not all monitors are supported, also Adapter to other Standard can make trouble. Design was tested with **DELL P2421**
USB Keyboard	Optional HW Can be used to get access to console which is show on DP
USB Stick	Optional HW USB was tested with USB memory stick
SATA Disk	Optional HW
PCIe Card	Optional HW
ETH cable	Optional HW Ethernet works with DHCP, but can be setup also manually
SD card	with fat32 partition

Table 6: Additional Hardware

4.5 Content

For general structure and usage of the reference design, see Project Delivery - AMD devices[3]

3 https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices

4.5.1 Design Sources

Type	Location	Notes
Vivado	<project folder>\block_design <project folder>\constraints <project folder>\ip_lib <project folder>\board_files	Vivado Project will be generated by TE Scripts
Vitis	<project folder>\sw_lib	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation
PetaLinux	<project folder>\os\petalinux	PetaLinux template with current configuration

Table 7: Design sources

4.5.2 Additional Sources

Type	Location	Notes
SI5338	<project folder>\misc\PLL\Si5338_B	SI5338 Project with current PLL Configuration
init.sh	<project folder>\misc\sd	Additional Initialization Script for Linux

Table 8: Additional design sources

4.5.3 Prebuilt

File	File-Extension	Description
BIF-File	*.bif	File with description to generate Bin-File

File	File-Extension	Description
BIN-File	*.bin	Flash Configuration File with Boot-Image (Zynq-FPGAs)
BIT-File	*.bit	FPGA (PL Part) Configuration File
Boot Script-File	*.scr	Distro Boot Script file
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Diverse Reports	---	Report files in different formats
Device Tree	*.dts	Device tree (2 possible, one for u-boot and one for linux)
Hardware-Platform-Description-File	*.xsa	Exported Vivado hardware description file for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
OS-Image	*.ub	Image with Linux Kernel (On Petalinux optional with Devicetree and RAM-Disk)
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

Table 9: Prebuilt files (only on ZIP with prebult content)

4.5.4 Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- TE0803 "StarterKit" Reference Design[4]

Basic description of TE Board Part Files is available on

4 https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/5.2x7.6/TE0803/Reference_Design/2022.2/StarterKit

5 Design Flow

⚠ Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first launch.

See also:

- AMD Development Tools[5]
- Vivado Projects - TE Reference Design[6]
- Project Delivery.[7]

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "_create_win_setup.cmd" on Windows OS and "_create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: Project Delivery Currently limitations of functionality[8]

⚠ **Caution!** Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\<project folder>")

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell:

_create_win_setup.cmd/_create_linux_setup.sh

```
------------------------Set design paths-----------------------------
-- Run Design with: _create_win_setup
-- Use Design Path: <absolute project path>
---------------------------------------------------------------------
-------------------------TE Reference Design--------------------------
---------------------------------------------------------------------
-- (0)  Module selection guide, project creation...prebuilt export...
-- (1)  Create minimum setup of CMD-Files and exit Batch
-- (2)  Create maximum setup of CMD-Files and exit Batch
-- (3)  (internal only) Dev
-- (4)  (internal only) Prod
-- (c)  Go to CMD-File Generation (Manual setup)
-- (d)  Go to Documentation (Web Documentation)
-- (g)  Install Board Files from Xilinx Board Store (beta)
-- (a)  Start design with unsupported Vivado Version (beta)
-- (x)  Exit Batch (nothing is done!)
----
Select (ex.:'0' for module selection guide)
```

2. Press 0 and enter to start "Module Selection Guide"
3. Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.

5 https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDevelopmentTools-XilinxSoftware-BasicUserGuides
6 https://wiki.trenz-electronic.de/display/PD/Vivado+Projects+-+TE+Reference+Design
7 https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices
8 https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices#ProjectDeliveryAMDdevices-Currentlylimitationsoffunctionality

- optional for manual changes: Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_guimode.cmd"

> ⚠ Note: Select correct one, see also Vivado Board Part Flow[9]
> - Important: Use Board Part Files, which ends with *_tebf0808

4. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into "\prebuilt\hardware\")

```
\prebuilt\hardware\")">
TE::hw_build_design -export_prebuilt
```

> ⓘ Using Vivado GUI is the same, except file export to prebuilt folder.

5. Create and configure your PetaLinux project with exported .xsa-file, see PetaLinux KICKstart[10]
   - use TE Template from "<project folder>\os\petalinux"
   - use exported .xsa file from "<project folder>\prebuilt\hardware\<short name>" . **Note:** HW Export from Vivado GUI creates another path as default workspace.
   - The build images are located in the "<plnx-proj-root>/images/linux" directory
6. Configure the **boot.scr** file as needed, see Distro Boot with Boot.scr[11]
7. Generate Programming Files with Vitis (recommended)
   a. Copy PetaLinux build image files to prebuilt folder
      - copy **u-boot.elf, system.dtb, bl31.elf**, **image.ub** and **boot.scr** from "<plnx-proj-root>/images/linux" to prebuilt folder

> ⓘ "<project folder>\prebuilt\os\petalinux\<ddr size>" or "<project folder>\prebuilt\os\petalinux\<short name>"

   b. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are defined in "test_board\sw_lib\apps_list.csv")

```
TE::sw_run_vitis -all
TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with
TE Scripts on Vivado TCL)
```

> ⚠ TCL scripts generate also platform project, this must be done manually in case GUI is used. See Vitis[12]

8. Generate Programming Files with Petalinux (alternative), see PetaLinux KICKstart[13]

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

9 https://wiki.trenz-electronic.de/display/PD/Vivado+Board+Part+Flow
10 https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart
11 https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr
12 https://wiki.trenz-electronic.de/display/PD/Vitis
13 https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart

6 Launch

6.1 Programming

⚠ Check Module and Carrier TRMs for proper HW configuration before you try any design.
Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Vivado/Vitis/SDSoC-Xilinx Software Programming and Debugging[14]

6.1.1 Get prebuilt boot binaries

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell
2. Press 0 and enter to start "Module Selection Guide"
   a. Select assembly version
   b. Validate selection
   c. Select create and open delivery binary folder

   ⓘ Note: Folder "<project folder>_binaries_<Article Name>" with subfolder "boot_<app name>" for different applications will be generated

6.1.2 QSPI-Boot mode

Option for **Boot.bin** on QSPI Flash.

1. Connect **JTAG** and power on carrier with module
2. Open Vivado Project with "vivado_open_existing_project_guimode.cmd" or if not created, create with "vivado_create_project_guimode.cmd"

   run on Vivado TCL (Script programs BOOT.bin on QSPI flash)

   ```
   TE::pr_program_flash -swapp hello_te0803
   ```
3. Copy **image.ub** and **boot.scr** on **SD** or **USB**
   - use files from "<project folder>_binaries_<Article Name>\boot_linux" from generated binary folder,see: Get prebuilt boot binaries (see page 29)
   - or use prebuilt file location, see "<project folder>\prebuilt\file_location.txt"
4. Set Boot Mode to **QSPI-Boot**
   - Depends on Carrier, see carrier TRM.
   - TEBF0808 automatically changes the boot mode to SD when the SD card is inserted. Optional CPLD firmware without boot mode change for microSD slot is available in the download area

6.1.3 SD-Boot mode

1. Copy **image.ub**, **boot.src** and **Boot.bin** on **SD**

14 https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools#AMDDevelopmentTools-XilinxSoftwareProgrammingandDebugging

- use files from "<project folder>_binaries_<Article Name>\boot_linux" from generated binary folder, see: Get prebuilt boot binaries (see page 29)
- or use prebuilt file location, see "<project folder>\prebuilt\file_location.txt"

2. Set Boot Mode to SD-Boot.
   - Depends on Carrier, see carrier TRM.
3. Insert SD-Card in SD-Slot.

6.1.4 JTAG

Not used on this Example.

6.2 Usage

1. Prepare HW like described on section Programming (see page 29)
2. Connect UART USB (JTAG XMOD)
3. Select SD Card as Boot Mode (or QSPI - depending on step 1)

   Note: See TRM of the Carrier, which is used.

   Starting with Petalinux version 2020.1, the industry standard "Distro-Boot" boot flow for U-Boot was introduced, which significantly expands the possibilities of the boot process and has the primary goal of making booting much more standardised and predictable.
   The boot options described above describe the common boot processes for this hardware; other boot options are possible.
   For more information see Distro Boot with Boot.scr[15]
4. (Optional with TEBF0808) Insert PCIe Card (detection depends on Linux driver. Only some basic drivers are installed)
5. (Optional with TEBF0808) Connect SATA Disc
6. (Optional with TEBF0808) Connect DisplayPort Monitor (List of usable Monitors: https://www.xilinx.com/support/answers/68671.html)
7. (Optional with TEBF0808) Connect Network Cable
8. Power On PCB
   boot process

   1. ZynqMP Boot ROM loads FSBL from SD/QSPI into OCM,

   2. FSBL init the PS, programs the PL using the bitstream and loads PMU, ATF and U-boot from SD/QSPI into DDR,

   3. U-boot loads Linux (**image.ub**) from SD/QSPI/... into DDR

6.2.1 Linux

1. Open Serial Console (e.g. putty)
   - Speed: 115200
   - select COM Port

     Win OS, see device manager, Linux OS see dmesg |grep tty (UART is *USB1)
2. Linux Console:

15 https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr

```
# password disabled
petalinux login: root
Password: root
```

Note: Wait until Linux boot finished

3. You can use Linux shell now.

```
i2cdetect -y -r 0   (check I2C Bus, replace 0 with other bus number is also
possible)
dmesg | grep rtc    (RTC check)
udhcpc              (ETH0 check)
lsusb               (USB check)
lspci               (PCIe check)
```

4. Option Features
    - Webserver to get access to Zynq
        - insert IP on web browser to start web interface
    - init.sh scripts
        - add init.sh script on SD, content will be load automatically on startup (template included in "<project folder>\misc\SD")

6.2.2 Vivado Hardware Manager

Open Vivado HW-Manager and add VIO signal to dashboard (*.ltx located on prebuilt folder).

- RGPIO Interface (**Important**: CPLD Firmware REV07 or newer is needed) for Control and Monitoring:
    - Set Enable to send Write date over RGPIO interface.
        - **Important use CPLD Firmware REV07 or newer:** https://wiki.trenz-electronic.de/display/PD/TEBF0808+CPLD
            - Buttons, LEDs, Status...
- Control:
    - LEDs: XMOD 2 (without green dot) and HD LED are accessible.
    - CAN_S

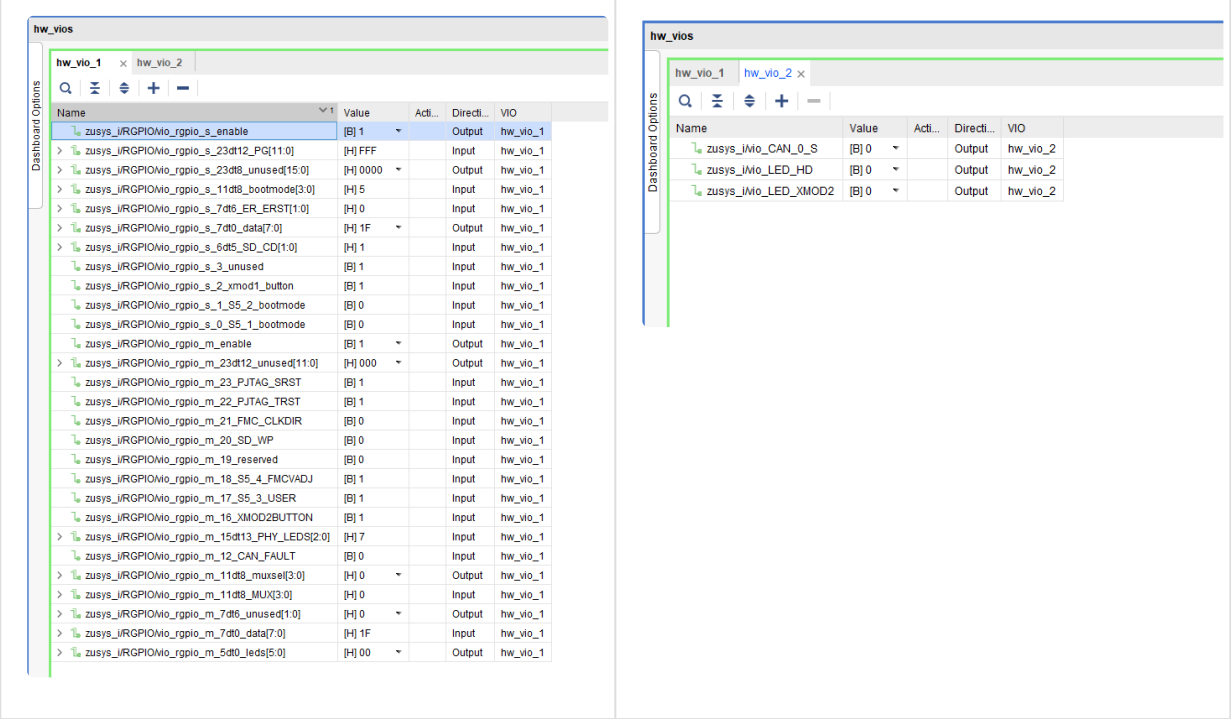

Table 10: Vivado Hardware Manager

Xilinx documentation for programming and debugging:

7 System Design - Vivado

7.1 Block Design

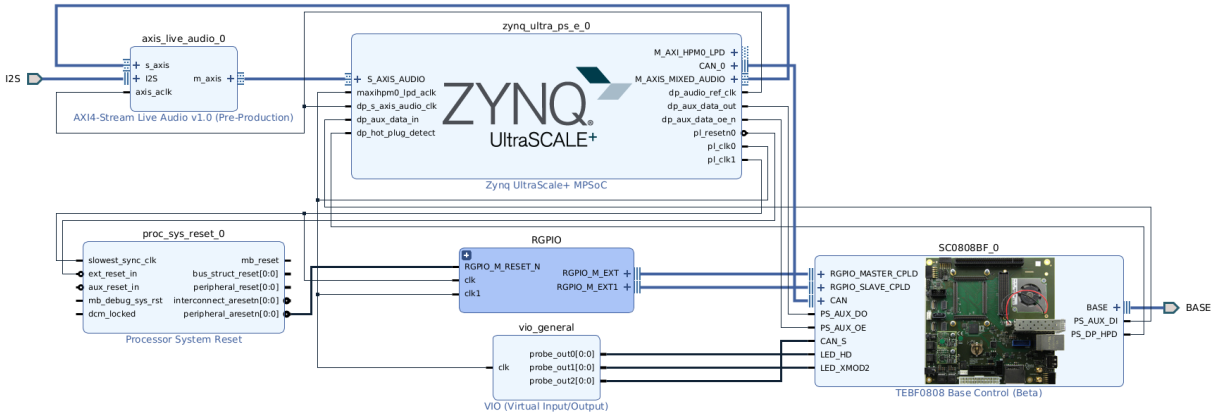

Figure 1: Block Design

7.1.1 PS Interfaces

Activated interfaces:

Type	Note
DDR	
QSPI	MIO
SD0	MIO
SD1	MIO
CAN0	EMIO
I2C0	MIO
PJTAG0	MIO

Type	Note
UART0	MIO
GPIO0	MIO
SWDT0..1	
TTC0..3	
GEM3	MIO
USB0	MIO/GTP
PCIe	MIO/GTP
SATA	GTP
DisplayPort	EMIO/GTP

Table 11: PS Interfaces

7.2 Constrains

7.2.1 Basic module constrains

_i_bitgen.xdc

```
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLNONE [current_design]
```

7.2.2 Design specific constrain

_i_io.xdc

```
# system controller ip
#LED_HD SC0 J3:31
#LED_XMOD SC17 J3:48
#CAN RX SC19 J3:52 B26_L11_P
#CAN TX SC18 J3:50 B26_L11_N
```

```
#CAN S  SC16 J3:46 B26_L1_N

set_property PACKAGE_PIN G14 [get_ports BASE_sc0]
set_property PACKAGE_PIN D15 [get_ports BASE_sc5]
set_property PACKAGE_PIN H13 [get_ports BASE_sc6]
set_property PACKAGE_PIN H14 [get_ports BASE_sc7]
set_property PACKAGE_PIN A13 [get_ports BASE_sc10_io]
set_property PACKAGE_PIN B13 [get_ports BASE_sc11]
set_property PACKAGE_PIN A14 [get_ports BASE_sc12]
set_property PACKAGE_PIN B14 [get_ports BASE_sc13]
set_property PACKAGE_PIN F13 [get_ports BASE_sc14]
set_property PACKAGE_PIN G13 [get_ports BASE_sc15]
set_property PACKAGE_PIN A15 [get_ports BASE_sc16]
set_property PACKAGE_PIN B15 [get_ports BASE_sc17]
set_property PACKAGE_PIN J14 [get_ports BASE_sc18]
set_property PACKAGE_PIN K14 [get_ports BASE_sc19 ]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc0]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc5]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc6]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc7]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc10_io]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc11]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc12]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc13]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc14]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc15]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc16]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc17]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc18]
set_property IOSTANDARD LVCMOS18 [get_ports BASE_sc19]

# Audio Codec
#LRCLK       J3:49
#BCLK        J3:51
#DAC_SDATA   J3:53
#ADC_SDATA   J3:55
set_property PACKAGE_PIN L13 [get_ports I2S_lrclk ]
set_property PACKAGE_PIN L14 [get_ports I2S_bclk ]
set_property PACKAGE_PIN E15 [get_ports I2S_sdin ]
set_property PACKAGE_PIN F15 [get_ports I2S_sdout ]
set_property IOSTANDARD LVCMOS18 [get_ports I2S_lrclk ]
set_property IOSTANDARD LVCMOS18 [get_ports I2S_bclk ]
set_property IOSTANDARD LVCMOS18 [get_ports I2S_sdin ]
set_property IOSTANDARD LVCMOS18 [get_ports I2S_sdout ]


# MGTs only for ZU4/5 Devices
#   Y6    MGT_224_CLK0_P -> B2B,J3-61 -> TEBF0808-04a_B230_CLK_P/CLK7_P ->
B2B,J2-13 -> floating
#   Y5    MGT_224_CLK0_N -> B2B,J3-59 -> TEBF0808-04a_B230_CLK_N/CLK7_N ->
B2B,J2-15 -> floating
#   V6    MGT_224_CLK1_P -> U5,38 -> Si5338 -> CLK1
#   V5    MGT_224_CLK1_N -> U5,37 -> Si5338 -> CLK1

#set_property PACKAGE_PIN Y6   [get_ports {MGT_CLK_IN_clk_p[0]}]
#set_property PACKAGE_PIN V6   [get_ports {MGT_CLK_IN_clk_p[1]}]
```

8 Software Design - Vitis

For Vitis project creation, follow instructions from:

Vitis[16]

8.1 Application

8.1.1 zynqmp_fsbl

TE modified 2022.2 FSBL

General:

- Modified Files: xfsbl_main.c, xfsbl_hooks.h/.c, xfsbl_board.h/.c (search for 'TE Mod' on source code)
- Add Files: te_xfsbl_hooks.h/.c (for hooks and board)
- General Changes:
    - Display FSBL Banner and Device Name

Module Specific:

- Add Files: all TE Files start with te_*
    - Si5338 Configuration
    - OTG+PCIe Reset over MIO
    - I2C MUX for EEPROM MAC

8.1.2 hello_te0803

Hello TE0803 is a Xilinx Hello World example as endless loop instead of one console output.

8.1.3 u-boot

U-Boot.elf is generated with PetaLinux. Vitis is used to generate Boot.bin.

Template location: "<project folder>\sw_lib\sw_apps\"

16 https://wiki.trenz-electronic.de/display/PD/Vitis

9 Software Design - PetaLinux

For PetaLinux installation and project creation, follow instructions from:

- PetaLinux KICKstart[17]

9.1 Config

Start with **petalinux-config** or **petalinux-config --get-hw-description**

Changes:

- select SD default instead of eMMC:
  - CONFIG_SUBSYSTEM_PRIMARY_SD_PSU_SD_1_SELECT=y
- add new flash partition for bootscr and sizing
  - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART0_SIZE=0xA00000
  - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART1_SIZE=0x2000000
  - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART2_SIZE=0x40000
  - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART3_NAME="bootscr"
  - CONFIG_SUBSYSTEM_FLASH_PSU_QSPI_0_BANKLESS_PART3_SIZE=0x80000
- Identification
  - CONFIG_SUBSYSTEM_HOSTNAME="Trenz"
  - CONFIG_SUBSYSTEM_PRODUCT="TE0803_TEBF0808"

9.2 U-Boot

Start with **petalinux-config -c u-boot**
Changes:

- MAC from eeprom together with uboot and device tree settings:
  - CONFIG_ENV_OVERWRITE=y
  - CONFIG_ZYNQ_MAC_IN_EEPROM is not set
  - CONFIG_NET_RANDOM_ETHADDR is not set
- Boot Modes:
  - CONFIG_QSPI_BOOT=y
  - CONFIG_SD_BOOT=y
  - CONFIG_ENV_IS_IN_FAT is not set
  - CONFIG_ENV_IS_IN_NAND is not set
  - CONFIG_ENV_IS_IN_SPI_FLASH is not set
  - CONFIG_SYS_REDUNDAND_ENVIRONMENT is not set
  - CONFIG_BOOT_SCRIPT_OFFSET=0x2A40000
- Identification
  - CONFIG_IDENT_STRING=" TE0803_TEBF0808"

Change platform-top.h:

```
#no changes
```

17 https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart

9.3 Device Tree

project-spec\meta-user\recipes-bsp\device-tree\files\system-user.dtsi

```
/include/ "system-conf.dtsi"


/*------------------ gtr --------------------*/

//https://xilinx-wiki.atlassian.net/wiki/spaces/A/pages/18841716/
Zynq+Ultrascale+MPSOC+Linux+SIOU+driver

/ {
  refclk3:psgtr_dp_clock {
          compatible = "fixed-clock";
          #clock-cells = <0x00>;
          clock-frequency = <27000000>;
  };

  refclk2:psgtr_pcie_usb_clock {
          compatible = "fixed-clock";
          #clock-cells = <0x00>;
          clock-frequency = <100000000>;
  };

  //refclk1:psgtr_unused_clock {
  //        compatible = "fixed-clock";
  //        #clock-cells = <0x00>;
  //        clock-frequency = <100000000>;
  //};

  refclk0:psgtr_sata_clock {
          compatible = "fixed-clock";
          #clock-cells = <0x00>;
          clock-frequency = <150000000>;
  };
};

&psgtr {
  clocks = <&refclk0 &refclk2 &refclk3>;
  /* ref clk instances used per lane */
  clock-names = "ref0\0ref2\0ref3";
};



/*------------------ SD --------------------*/
&sdhci0 {
    // disable-wp;
    no-1-8-v;

};
```

```
&sdhci1 {
    // disable-wp;
    no-1-8-v;

};


/*------------------- USB --------------------*/
&dwc3_0 {
    status = "okay";
    dr_mode = "host";
    snps,usb3_lpm_capable;
    snps,dis_u3_susphy_quirk;
    snps,dis_u2_susphy_quirk;
    phy-names = "usb2-phy","usb3-phy";
    maximum-speed = "super-speed";
};


/*------------------ ETH PHY -------------------*/
&gem3 {
    /delete-property/ local-mac-address;
    phy-handle = <&phy0>;

    nvmem-cells = <&eth0_addr>;
    nvmem-cell-names = "mac-address";

    phy0: phy0@1 {
        device_type = "ethernet-phy";
        reg = <1>;
    };
};

/*----------------- SATA PHY -------------------*/
&sata {

            ceva,p0-burst-params = <0x13084a06>;
            ceva,p0-cominit-params = <0x18401828>;
            ceva,p0-comwake-params = <0x614080e>;
            ceva,p0-retry-params = <0x96a43ffc>;
            ceva,p1-burst-params = <0x13084a06>;
            ceva,p1-cominit-params = <0x18401828>;
            ceva,p1-comwake-params = <0x614080e>;
            ceva,p1-retry-params = <0x96a43ffc>;

};


/*------------------- QSPI --------------------*/
&qspi {
    #address-cells = <1>;
    #size-cells = <0>;
    status = "okay";
    flash0: flash@0 {
        compatible = "jedec,spi-nor";
```

```
        reg = <0x0>;
        #address-cells = <1>;
        #size-cells = <1>;
    };
};


/*------------------ I2C --------------------*/
&i2c0 {
    i2cswitch@73 { // u
        compatible = "nxp,pca9548";
        #address-cells = <1>;
        #size-cells = <0>;
        reg = <0x73>;
        i2c-mux-idle-disconnect;
        i2c@0 { // MCLK TEBF0808 SI5338A, 570FBB000290DG_unassembled
            reg = <0>;
        };
        i2c@1 { // SFP TEBF0808 PCF8574DWR
            reg = <1>;
        };
        i2c@2 { // PCIe
            reg = <2>;
        };
        i2c@3 { // SFP1 TEBF0808
            reg = <3>;
        };
        i2c@4 {// SFP2 TEBF0808
            reg = <4>;
        };
        i2c@5 { // TEBF0808 EEPROM
            reg = <5>;
            eeprom: eeprom@50 {
                compatible = "microchip,24aa025", "atmel,24c02";
                reg = <0x50>;

                #address-cells = <1>;
                #size-cells = <1>;
                eth0_addr: eth-mac-addr@FA {
                  reg = <0xFA 0x06>;
                };
           };
        };
        i2c@6 { // TEBF0808 FMC
            reg = <6>;
        };
        i2c@7 { // TEBF0808 USB HUB
            reg = <7>;
        };
    };
    i2cswitch@77 { // u
        compatible = "nxp,pca9548";
        reg = <0x77>;
        i2c-mux-idle-disconnect;
        i2c@0 { // TEBF0808 PMOD P1
            reg = <0>;
```

```
        };
        i2c@1 { // i2c Audio Codec
            reg = <1>;
            /*
            adau1761: adau1761@38 {
                compatible = "adi,adau1761";
                reg = <0x38>;
            };
            */
        };
        i2c@2 { // TEBF0808 Firefly A
            reg = <2>;
        };
        i2c@3 { // TEBF0808 Firefly B
            reg = <3>;
        };
        i2c@4 { //Module PLL Si5338 or SI5345
            reg = <4>;
        };
        i2c@5 { //TEBF0808 CPLD
            reg = <5>;
        };
        i2c@6 { //TEBF0808 Firefly PCF8574DWR
            reg = <6>;
        };
        i2c@7 { // TEBF0808 PMOD P3
            reg = <7>;
        };
    };
};
```

9.4 Kernel

Start with **petalinux-config -c kernel**

Changes:

- Only needed to fix JTAG Debug issue:
  - # CONFIG_CPU_FREQ is not set
- Support PCIe memory card
  - CONFIG_NVME_CORE=y
  - CONFIG_BLK_DEV_NVME=y
  - # CONFIG_NVME_MULTIPATH is not set
  - # CONFIG_NVME_HWMON is not set
  - CONFIG_NVME_TARGET=y
  - # CONFIG_NVME_TARGET_PASSTHRU is not set
  - # CONFIG_NVME_TARGET_LOOP is not set
  - # CONFIG_NVME_TARGET_FC is not set
  - # CONFIG_NVME_TARGET_TCP is not set
  - CONFIG_SATA_AHCI=y
  - CONFIG_SATA_MOBILE_LPM_POLICY=0

9.5 Rootfs

Start with **petalinux-config -c rootfs**

Changes:

- For web server app:
  - CONFIG_busybox-httpd=y
- For additional test tools only:
  - CONFIG_i2c-tools=y
  - CONFIG_packagegroup-petalinux-utils=y (util-linux,cpufrequtils,bridge-utils,mtd-utils,usbutils,pciutils,canutils,i2c-tools,smartmontools,e2fsprogs)
- For auto login:
  - CONFIG_auto-login=y
  - CONFIG_ADD_EXTRA_USERS="root:root;petalinux:;"

9.6 FSBL patch (alternative for vitis fsbl trenz patch)

See "<project folder>\os\petalinux\project-spec\meta-user\recipes-bsp\embeddedsw"

> ⚠ te_* files are identical to files in "<project folder>\sw_lib\sw_apps\zynqmp_fsbl\src" except for the PLL files (SI5338) which depend on PLL revision. The PLL files may have to be copied again manually into the appropriate petalinux folder "<project folder>\os\petalinux\project-spec\meta-user\recipes-bsp\embeddedsw\fsbl-firmware\git\lib\sw_apps\zynqmp_fsbl\src"

9.7 Applications

See "<project folder>\os\petalinux\project-spec\meta-user\recipes-apps\"

9.7.1 startup

Script App to load init.sh from SD Card if available.

9.7.2 webfwu

Webserver application suitable for Zynq access. Need busybox-httpd

10 Additional Software

10.1 SI5338

File location "<project folder>\misc\PLL\Si5338_B\Si5338-*.slabtimeproj"

General documentation how you work with this project will be available on Si5338[18]

18 https://wiki.trenz-electronic.de/display/PD/Si5338

11 Appx. A: Change History and Legal Notices

11.1 Document Change History

To get content of older revision go to "Change History" of this page and select older document revision number.

Date	Document Revision	Authors	Description
2023-09-20	v.38 (see page 6)	@ Manuela Strücker[19]	• Release 2022.2 • new assembly variants
2022-10-17	v.36	Manuela Strücker	• script update
2022-09-06	v.35	Manuela Strücker	• new assembly variants
2022-07-15	v.33	Manuela Strücker	• Release 2021.2
2021-09-09	v.29	Manuela Strücker	• Release 2020.2 • update document style
2020-04-06	v.28	John Hartfiel	• new assembly variants
2020-03-25	v.27	John Hartfiel	• script update
2020-02-25	v.26	John Hartfiel	• Update requirement section
2020-01-23	v.25	John Hartfiel	• Release 2019.2
2019-05-07	v.24	John Hartfiel	• Release 2018.3
2018-10-26	v.21	John Hartfiel	• new assembly variant
2018-08-14	v.19	John Hartfiel	• design update

19 https://wiki.trenz-electronic.de/display/~m.struecker

Date	Document Revision	Authors	Description
2018-07-23	v.18	John Hartfiel	• new assembly variant
2018-07-20	v.16	John Hartfiel	• Release 2018.2
2018-05-17	v.14	John Hartfiel	• new assembly variant • solved known issues
2018-04-30	v.13	John Hartfiel	• Update known Issues
2018-04-11	v.12	John Hartfiel	• bugfix board part files
2018-02-13	v.11	John Hartfiel	• new assembly variant • solved known issues
2018-01-29	v.4	John Hartfiel	• Update known Issues
2018-01-18	v.3	John Hartfiel	• Release 2017.4
	All	@ John Hartfiel[20] , Manuela Strücker[21]	

Table 12: Document change history.

11.2 Legal Notices

11.3 Data Privacy

Please also note our data protection declaration at https://www.trenz-electronic.de/en/Data-protection-Privacy

11.4 Document Warranty

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20 https://wiki.trenz-electronic.de/display/~j.hartfiel
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11.8 Environmental Protection

To confront directly with the responsibility toward the environment, the global community and eventually also oneself. Such a resolution should be integral part not only of everybody's life. Also enterprises shall be conscious of their social responsibility and contribute to the preservation of our common living space. That is why Trenz Electronic invests in the protection of our Environment.

11.9 REACH, RoHS and WEEE

REACH

Trenz Electronic is a manufacturer and a distributor of electronic products. It is therefore a so called downstream user in the sense of REACH[22]. The products we supply to you are solely non-chemical products (goods). Moreover and under normal and reasonably foreseeable circumstances of application, the goods supplied to you shall not release any substance. For that, Trenz Electronic is obliged to neither register nor to provide safety data sheet. According to present knowledge and to best of our knowledge, no SVHC (Substances of Very High Concern) on the Candidate List[23] are contained in our products. Furthermore, we will immediately and unsolicited inform our customers in compliance with REACH - Article 33 if any substance present in our goods (above a concentration of 0,1 % weight by weight) will be classified as SVHC by the European Chemicals Agency (ECHA)[24].

RoHS

22 http://guidance.echa.europa.eu/
23 https://echa.europa.eu/candidate-list-table
24 http://www.echa.europa.eu/

Trenz Electronic GmbH herewith declares that all its products are developed, manufactured and distributed RoHS compliant.

WEEE

Information for users within the European Union in accordance with Directive 2002/96/EC of the European Parliament and of the Council of 27 January 2003 on waste electrical and electronic equipment (WEEE).

Users of electrical and electronic equipment in private households are required not to dispose of waste electrical and electronic equipment as unsorted municipal waste and to collect such waste electrical and electronic equipment separately. By the 13 August 2005, Member States shall have ensured that systems are set up allowing final holders and distributors to return waste electrical and electronic equipment at least free of charge. Member States shall ensure the availability and accessibility of the necessary collection facilities. Separate collection is the precondition to ensure specific treatment and recycling of waste electrical and electronic equipment and is necessary to achieve the chosen level of protection of human health and the environment in the European Union. Consumers have to actively contribute to the success of such collection and the return of waste electrical and electronic equipment. Presence of hazardous substances in electrical and electronic equipment results in potential effects on the environment and human health. The symbol consisting of the crossed-out wheeled bin indicates separate collection for waste electrical and electronic equipment.

Trenz Electronic is registered under WEEE-Reg.-Nr. DE97922676.

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